



Dear Valued Customer

Issue date: March 2026 / TG131

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General Manager
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General Purpose Devices Division
General Purpose Devices & Modules Headquarters
ROHM Co., Ltd.

Notification of Product/Process Change

Doc. No.: 3026001

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

Issue Date: March 1, 2026

Title of change	Change of wafer manufacturing site from ROHM HQ Plant to Shiga Plant (Small Signal Transistors)	
Affected product(s)	Manufacturer part number	Customer part number
	Refer attached sheet	0
Detailed description of change	Before	After
	Front-end fabrication plant; Kyoto	Front-end fabrication plant; Shiga
Reason for change	As part of the consolidation of production lines, the front-end operations will be centralized at the Shiga plant.	
Anticipated impact on quality	This change will not have any impact on quality.	
Identification of change	It can be identified through traceability from the assembly lot number.	
Planned first ship date	April 1, 2027	
Qualification plan schedule, results and samples	If required, please contact the local ROHM sales office or the authorized distributor.	
Comments	If you need existing products, please place your orders for the required quantities by March 31, 2027. Following the consolidated production, we would appreciate your cooperation in receiving the products in a single shipment.	
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.	
Notes		